

# **FDMS8090** PowerTrench<sup>®</sup> Symmetrical Dual 100 V N-Channel MOSFET

### Features

- Max  $r_{DS(on)}$  = 13 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 10 A
- Max  $r_{DS(on)} = 20 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 8 \text{ A}$
- Low inductance packaging shortens rise/fall times, resulting in lower switching losses
- MOSFET integration enables optimum layout for lower circuit inductance and reduced switch node ringing
- 100% UIL tested
- RoHS Compliant

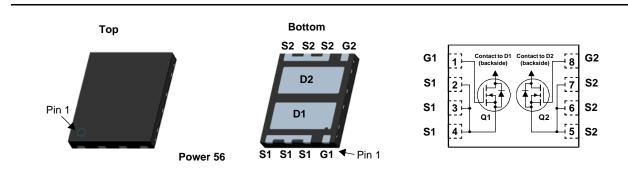


## **General Description**

This device includes two fast switching (Qgd minimized) 100V N-Channel MOSFETs in a dual Power 56 (5 mm X 6 mm MLP) package. The package is enhanced for exceptional thermal performance.

### **Applications**

- Bridge Topologies
- Synchronous Rectifier Pair
- Motor Drives



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		40		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	10	Α	
	-Pulsed		(Note 4)	120		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	253	mJ	
P <sub>D</sub>	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			59	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.2	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

### Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	55	C/ VV

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8090	FDMS8090	Power 56	13 "	12 mm	3000 units

April 2013

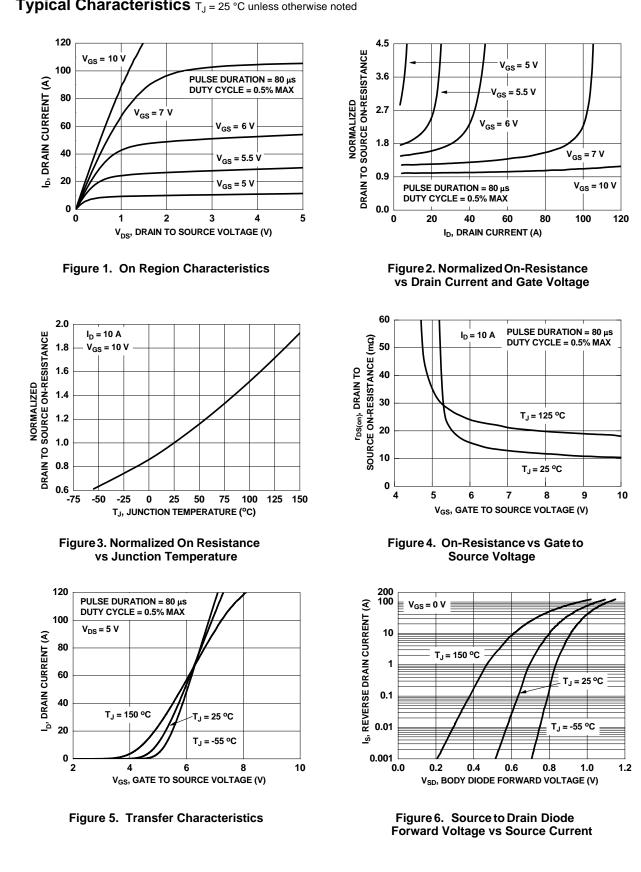
0 V nced to 25 °C 0 V = 0 V 0 μA nced to 25 °C A A, T <sub>J</sub> = 125 °C A 0 V,	2.0	70 70 3.0 -10 11 15 18 24 24	1 ±100 4.0 13 20 20	V mV/°C μA nA V mV/°C mΩ S
nced to 25 °C 0 V $\approx 0$ V $\rightarrow \mu A$ nced to 25 °C $\Rightarrow A$ A A		3.0 -10 11 15 18 24	±100 4.0 13 20	mV/°C μΑ nA V mV/°C mΩ
nced to 25 °C 0 V $\approx 0$ V $\rightarrow \mu A$ nced to 25 °C $\Rightarrow A$ A A	2.0	3.0 -10 11 15 18 24	±100 4.0 13 20	μA nA V mV/°C mΩ
$= 0 V$ $= 0 \mu A$ $= 100 \mu A$	2.0	-10 11 15 18 24	±100 4.0 13 20	NA V mV/°C mΩ
0 μA need to 25 °C A A, T <sub>J</sub> = 125 °C A	2.0	-10 11 15 18 24	4.0 13 20	V mV/°C mΩ
nced to 25 °C A A, $T_J = 125$ °C A	2.0	-10 11 15 18 24	13 20	mV/°C mΩ
nced to 25 °C A A, $T_J = 125$ °C A	2.0	-10 11 15 18 24	13 20	mV/°C mΩ
nced to 25 °C A A, $T_J = 125$ °C A		-10 11 15 18 24	13 20	mV/°C mΩ
A A, T <sub>J</sub> = 125 °C A		11 15 18 24	20	mΩ
A, T <sub>J</sub> = 125 °C A		15 18 24	20	
A, T <sub>J</sub> = 125 °C A		18 24	-	
A		24	20	S
		ļ		S
0 V,		1285		
) V,		1285		
) V, –		1200	1800	pF
		301	400	pF
		16	28	pF
	0.1	1.7	3.5	Ω
		10.6	21	ns
$V_{\text{DD}} = 50 \text{ V}, \text{ I}_{\text{D}} = 10 \text{ A},$ $V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		4.6	10	ns
		17.4	31	ns
		4	10	ns
		19	27	nC
V <sub>DD</sub> = 50 V,		10	15	nC
I <sub>D</sub> = 10 A		6.1		nC
_		4.1		nC
(Note 2)		0.7	1.2	
(Note 2)		0.8	1.3	V
		49	78	ns
0 A/μs		54	86	nC
	$P_{DD} = 50 V,$ $I_D = 10 A$ (Note 2) A (Note 2) O A/μs FR-4 material. R <sub>θJC</sub> is	$P_{DD} = 50 V,$ $I_D = 10 A$ (Note 2) A (Note 2) D A/μs FR-4 material. R <sub>θJC</sub> is guaranteed	A,       4.6 $6 \Omega$ 17.4         4       19         V <sub>DD</sub> = 50 V,       10         I <sub>D</sub> = 10 A       6.1         4.1       4.1         (Note 2)       0.7         Λ (Note 2)       0.8         0 A/µs       54	A,       4.6       10         6 Ω       17.4       31         4       10         V <sub>DD</sub> = 50 V,       10       15         I <sub>D</sub> = 10 A       6.1       4.1         (Note 2)       0.7       1.2         Λ       (Note 2)       0.8       1.3         0 A/µs       54       86

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

3.  $E_{AS}$  of 253 mJ is based on starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 13 A,  $V_{DD}$  = 100 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 29 A.

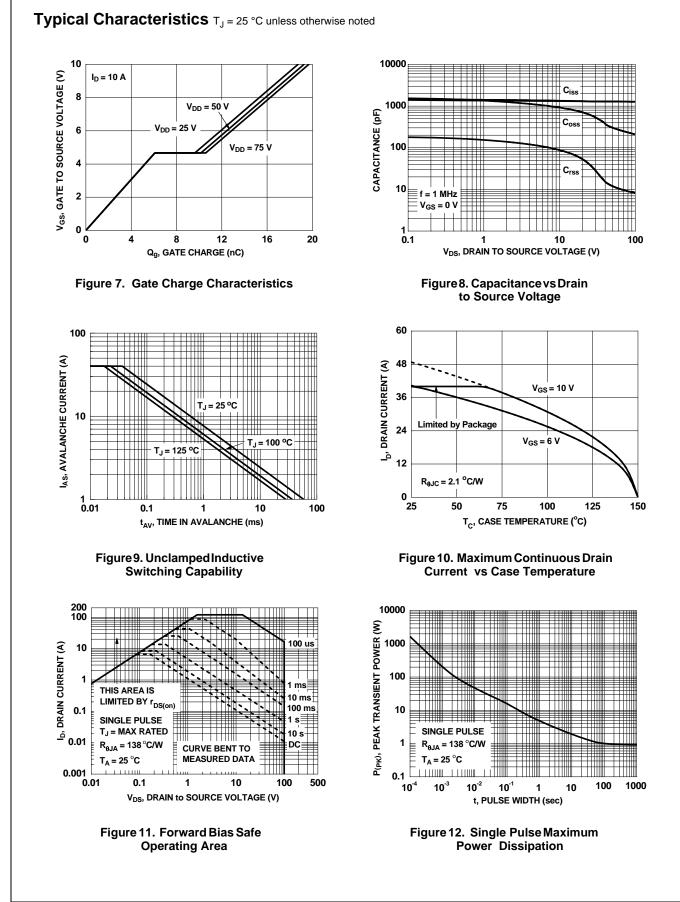
4. Pulsed Id limited by junction temperature,td<=10uS. Please refer to SOA curve for more details.

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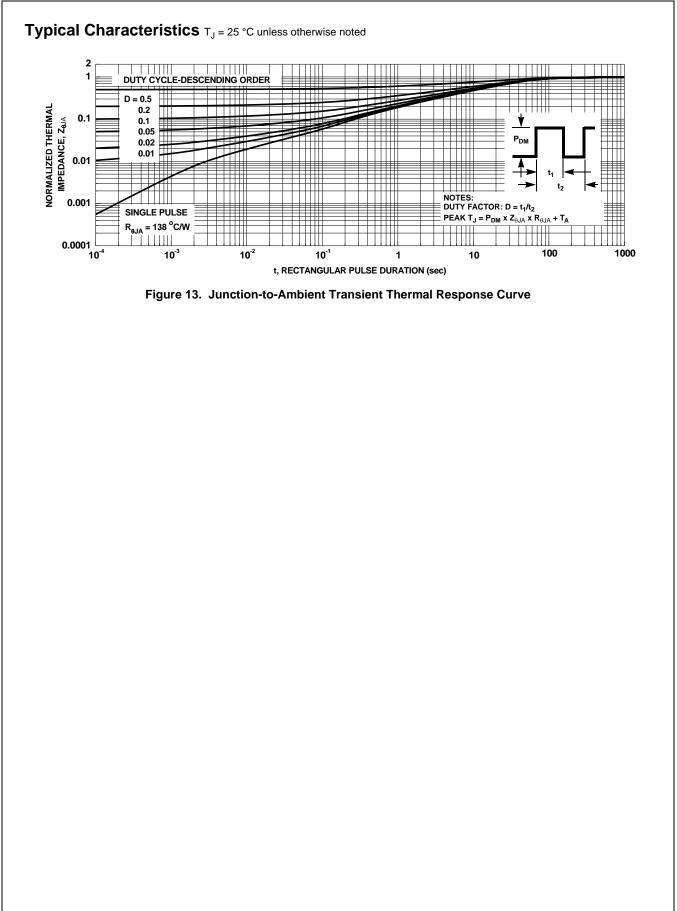
### Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

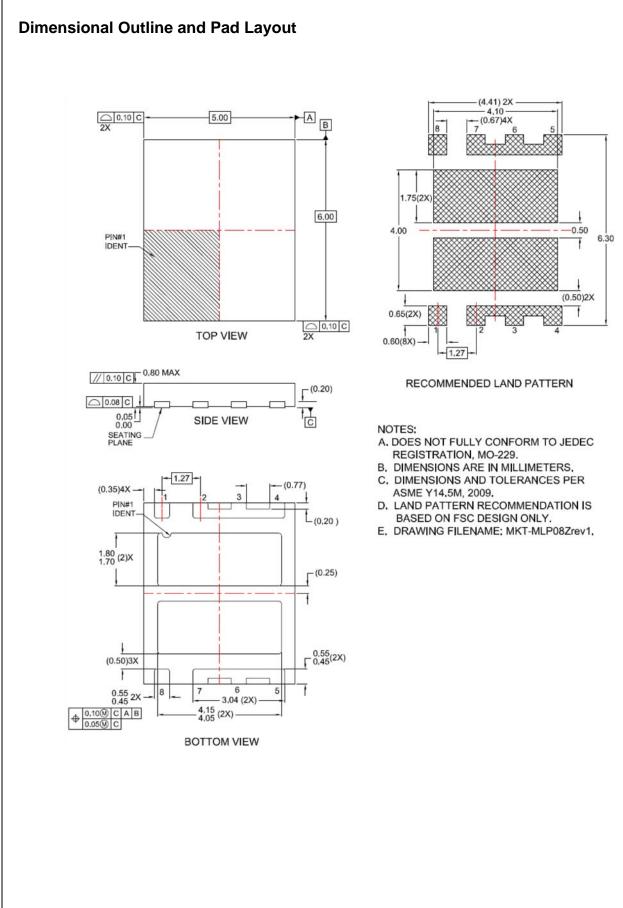




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